

UNITED STATES PATENT AND TRADEMARK OFFICE

jr/

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

| PPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO |
|------------------------------------------|---------------------------|----------------------|--------------------------|-----------------|
| 10/708,904 | 03/31/2004 | Ko-Hsing Chang | 12694-US-PA | 2903 |
| 31561 759 | 90 09/15/2005 | | EXAMINER | |
| JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE | | | TOLEDO, FERNANDO L | |
| 7 FLOOR-1, NO ROOSEVELT R | O. 100 ROAD, SECTION 2 | | ART UNIT | PAPER NUMBER |
| TAIPEI, 100 | • | | 2823. | |
| TAIWAN | | | DATE MAII PD: 00/15/2009 | _ |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | Application No. | Applicant(s) | | | | | |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|--------------|--|--|--|--|
| | 10/708,904 | CHANG ET AL. | | | | | |
| Office Action Summary | Examiner | Art Unit | , | | | | |
| | Fernando L. Toledo | 2823 | | | | | |
| The MAILING DATE of this communication Period for Reply | appears on the cover sh | eet with the correspondence a | dress | | | | |
| A SHORTENED STATUTORY PERIOD FOR RE WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFF after SIX (6) MONTHS from the mailing date of this communication - If NO period for reply is specified above, the maximum statutory pe - Failure to reply within the set or extended period for reply will, by st Any reply received by the Office later than three months after the mearned patent term adjustment. See 37 CFR 1.704(b). | G DATE OF THIS COM! R 1.136(a). In no event, however, riod will apply and will expire SIX atute, cause the application to be | MUNICATION. may a reply be timely filed (6) MONTHS from the mailing date of this come ABANDONED (35 U.S.C. § 133). | , | | | | |
| Status | | | | | | | |
| 1) Responsive to communication(s) filed on 3 | 1 March 2004 | | | | | | |
| ,— , | This action is non-final. | | | | | | |
| · · · · · · · · · · · · · · · · · · · | _ | | | | | | |
| , | closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. | | | | | | |
| Disposition of Claims | • • • • • • • • • • • • • • • • • • • • | | | | | | |
| · <u> </u> | ion | | | | | | |
| , | Claim(s) 1-18 is/are pending in the application. | | | | | | |
| 4a) Of the above claim(s) is/are withdrawn from consideration. 5.☑ Claim(s) 8-18 is/are allowed | | | | | | | |
| 5)⊠ Claim(s) <u>8-18</u> is/are allowed. 6)⊠ Claim(s) <u>1-7</u> is/are rejected. | | | | | | | |
| · | | | | | | | |
| 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement. | | | | | | | |
| are subject to restriction ar | id/or election requireme | | • | | | | |
| Application Papers | | | | | | | |
| 9)⊠ The specification is objected to by the Exan | niner. | | | | | | |
| 10)⊠ The drawing(s) filed on <u>31 March 2004</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner. | | | | | | | |
| Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). | | | | | | | |
| Replacement drawing sheet(s) including the cor | теction is required if the dr | awing(s) is objected to. See 37 C | FR 1.121(d). | | | | |
| 11)☐ The oath or declaration is objected to by the | e Examiner. Note the at | ached Office Action or form P | TO-152. | | | | |
| Priority under 35 U.S.C. § 119 | | | | | | | |
| 12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a)□ All b)□ Some * c)⊠ None of: | | | | | | | |
| | 1. Certified copies of the priority documents have been received. | | | | | | |
| | | | | | | | |
| 3. Copies of the certified copies of the | <u>-</u> | | Stage | | | | |
| application from the International Bu | , | | | | | | |
| * See the attached detailed Office action for a list of the certified copies not received. | | | | | | | |
| | | | , | | | | |
| | • | | | | | | |
| Attachment(s) | 🗖 . | | | | | | |
| 1) Motice of References Cited (PTO-892) 4) Interview Summary (PTO-413) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date | | | | | | | |
| 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB | /08) 5) 🔲 Not | ice of Informal Patent Application (PT | O-152) | | | | |
| Paper No(s)/Mail Date <u>20040331</u> . 6) Other: | | | | | | | |

DETAILED ACTION

Specification

1. The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- Claims 1, 3 7 are rejected under 35 U.S.C. 102(e) as being anticipated by Yoo et al. (U.
 Patent 6,835,621 B2).
- 4. In re claim 1, Yoo, in the U. S. Patent 6,835.621 B2; figures 1 5 and related text, discloses forming a bottom dielectric layer 213 on a substrate 200; forming a charge trapping layer 215 on the bottom dielectric layer, pattering the charge trapping layer, for forming a trench exposing a portion of the bottom dielectric layer (Figure 4); forming a top dielectric layer 219 over the substrate, covering the charge trapping layer and the exposed bottom dielectric layer; forming a conductive layer 240 over the substrate, covering the top dielectric layer; patterning the conductive layer, the top dielectric layer, the charge trapping layer and the bottom dielectric layer, for forming a stacked structure, wherein a width of the stacked structure is larger than a

Application/Control Number: 10/708,904 Page 3

Art Unit: 2823

width of the trench (Figure 5); and forming source/drain regions in the substrate adjacent to edges of the stacked structure (Column 4, Lines 35 - 39).

- 5. In re claim 3, Yoo discloses wherein the step of patterning the conductive layer, the top dielectric layer, the charge trapping layer and the bottom dielectric layer includes aligning the trench to a center of the stacked structure (Figure 5).
- 6. In re claim 4, Yoo discloses wherein the step of forming the bottom dielectric layer includes forming a silicon oxide layer on a surface of the substrate by a thermal oxidation process (Column 3, Lines 15-20).
- 7. In re claim 5, Yoo discloses wherein the step of forming the charge-trapping layer includes forming a silicon nitride layer on the bottom dielectric layer by a chemical vapor deposition process (Column 3, Lines 20 25).
- 8. In re claim 6, Yoo discloses wherein the material of the conductive layer includes polysilicon (Column 4, Line 18).
- 9. In re claim 7, Yoo discloses wherein the material of the charge-trapping layer is selected from a group consisting of silicon nitride, tantalum oxide, SrTiO₃, and hafnium oxide (Column 3, Lines 15 20).

Claim Rejections - 35 USC § 103

- 10. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Application/Control Number: 10/708,904

Art Unit: 2823

11. Claim 2 is rejected under 35 U.S.C. 103(a) as being unpatentable over Yoo as applied to

Page 4

claims 1, 3 – 7 above, and further in view of Wolf (Silicon Processing for the VLSI Era Volume

2: Process Integration).

12. In re claim 2, Yoo does not teach forming LDDs or sidewall spacers.

However, Wolf, in the textbook, Silicon Processing for the VLSI Era Volume 2: Process

Integration discloses that to overcome hot-carrier effects that degrade the devices LDDs must be

used. Sidewall spacers will aid in forming self-aligned source and drain regions for the device

(page 354).

It would have been obvious to one of ordinary skill in the art at the time the invention

was made to form LDDs in the invention of Yoo, since as taught by Wolf they overcome the hot-

carrier effect that degrade the devices, also the use of sidewall spacers will aid in the formation

of self-aligned source and drain regions.

Allowable Subject Matter

13. Claims 8 - 18 are allowed over the prior art of record.

14. The following is a statement of reasons for the indication of allowable subject matter:

Yoo substantially discloses the claimed invention. Yoo does not teach, suggest or disclose

"forming several of first spacers on sidewall of the first trench; using the first spacers as an

etching mask and etching the first top dielectric layer and the charge trapping layer for forming a

second trench; removing the spacers." It would be improper hindsight to argue that Yoo can be

modified into having sacrificial spacers inside the trench.

Art Unit: 2823

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Fernando L. Toledo whose telephone number is 571-272-1867. The examiner can normally be reached on Mon-Thu 7am to 5:30pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith can be reached on 571-272-1907. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Fernando L. Toledo

Examiner

Art Unit 2823

flt

13 September 2005